

December 20, 2018

To Whom It May Concern:

Company name: Fujimi Incorporated  
Representative: Keishi Seki, President  
Listings: Tokyo and Nagoya Stock Exchanges  
(Stock code: 5384)  
Contact: Akira Suzuki, Director,  
Finance Division  
Phone: +81-52-503-8181

FUJIMI INCORPORATED ANNOUNCES SUSPENSION OF COLLABORATION  
FOR ADVANCED SLURRY DEVELOPMENT

Kiyosu, Aichi, December 20, 2018 – Fujimi Incorporated (TSE: 5384), a pioneer in the field of manufacturing synthetic precision abrasives, leading supplier of silicon wafer lapping abrasives, polishing slurries today has announced the suspension of the plans to collaborate, with Cabot Microelectronics Corporation (Nasdaq: CCMP), the world's leading supplier of chemical mechanical planarization (CMP) polishing slurries and the second largest CMP pads supplier to the semiconductor industry, in the development of certain advanced CMP solutions for the semiconductor industry.

Fujimi Incorporated and Cabot Microelectronics Corporation had announced on March 29, 2018 their intent to collaborate in the development of certain advanced IC CMP solutions for the semiconductor industry. However, due to other priorities at both companies at this time, the parties have decided to suspend further discussions regarding collaboration in IC CMP solutions for the time being.